

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum forward voltage drop	$V_{FM}^{(1)}$	20 A	$T_J = 25\text{ }^{\circ}\text{C}$	0.59	V	
		40 A		0.78		
		20 A	$T_J = 125\text{ }^{\circ}\text{C}$	0.56		
		40 A		0.72		
Maximum instantaneous reverse current	$I_{RM}^{(1)}$	$T_J = 25\text{ }^{\circ}\text{C}$	Rated DC voltage	1.75	mA	
		$T_J = 100\text{ }^{\circ}\text{C}$		50		
		$T_J = 125\text{ }^{\circ}\text{C}$		85		
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$		0.29	V	
Forward slope resistance	r_t			10.3	mΩ	
Maximum junction capacitance	C_T	$V_R = 5\text{ V}_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^{\circ}\text{C}$		900	pF	
Typical series inductance	L_S	Measured from top of terminal to mounting plane		7.5	nH	
Maximum voltage rate of change	dV/dt	Rated V_R		10 000	V/μs	

Note

⁽¹⁾ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction temperature range		T _J		- 55 to 150	°C
Maximum storage temperature range		T _{Stg}		- 55 to 175	
Maximum thermal resistance, junction to case per package		R _{thJC}	DC operation	1.4	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.7	
Approximate weight				6	g
				0.21	oz.
Mounting torque	minimum			6 (5)	kgf · cm (lbf · in)
	maximum			12 (10)	
Device marking			Case style TO-247AC (JEDEC)	MBR4045WT	

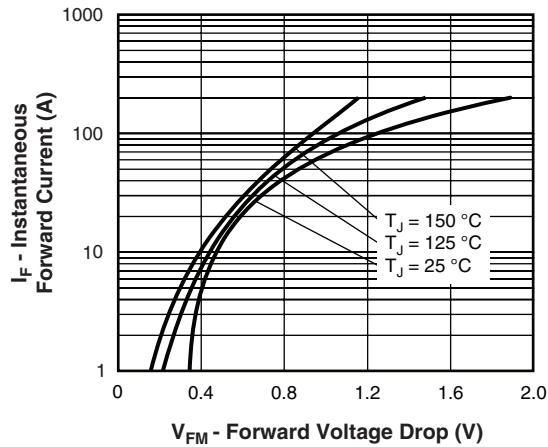


Fig. 1 - Maximum Forward Voltage Drop Characteristics

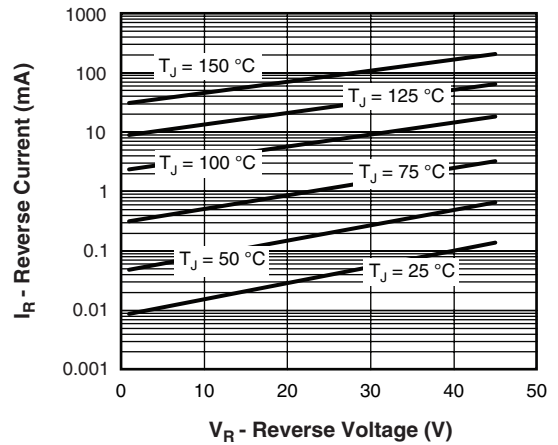


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

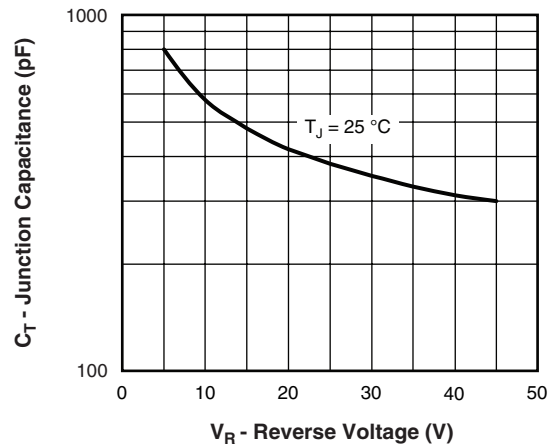
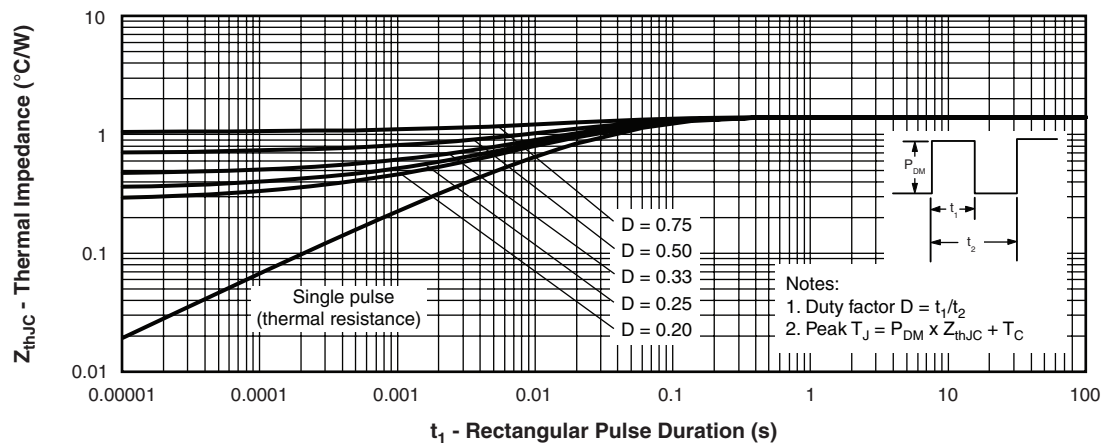


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

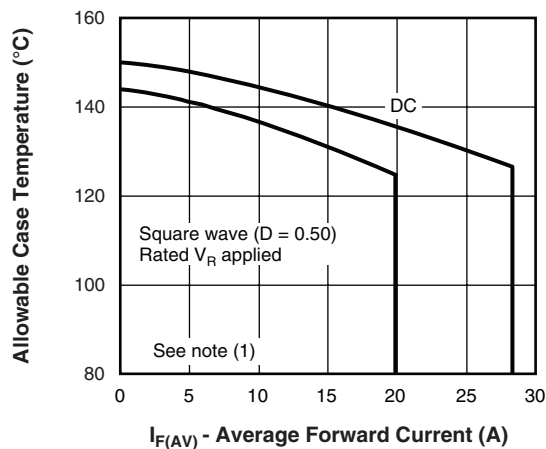


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

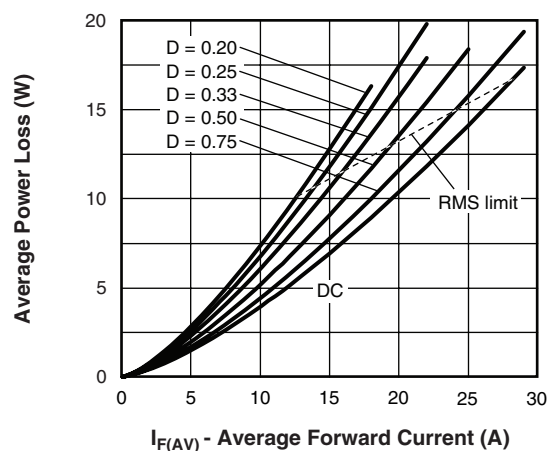


Fig. 6 - Forward Power Loss Characteristics

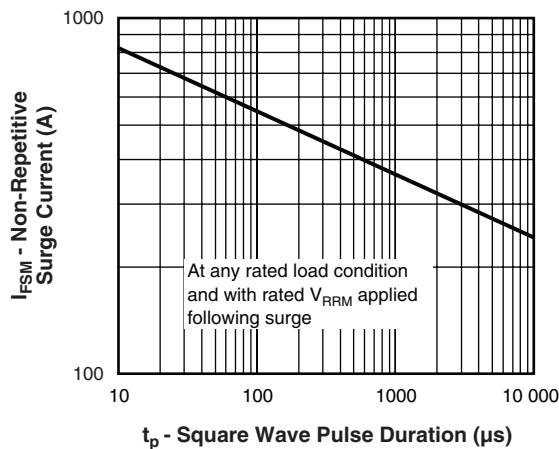


Fig. 7 - Maximum Non-Repetitive Surge Current

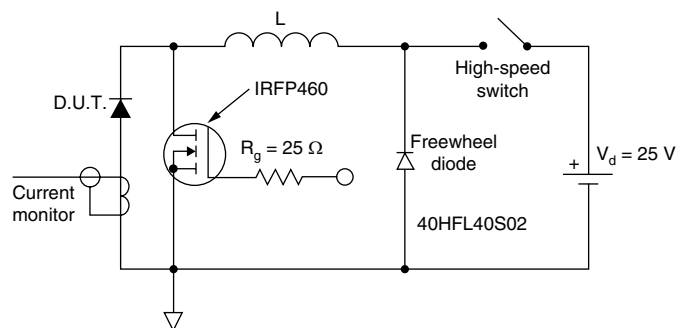


Fig. 8 - Unclamped Inductive Test Circuit

Note

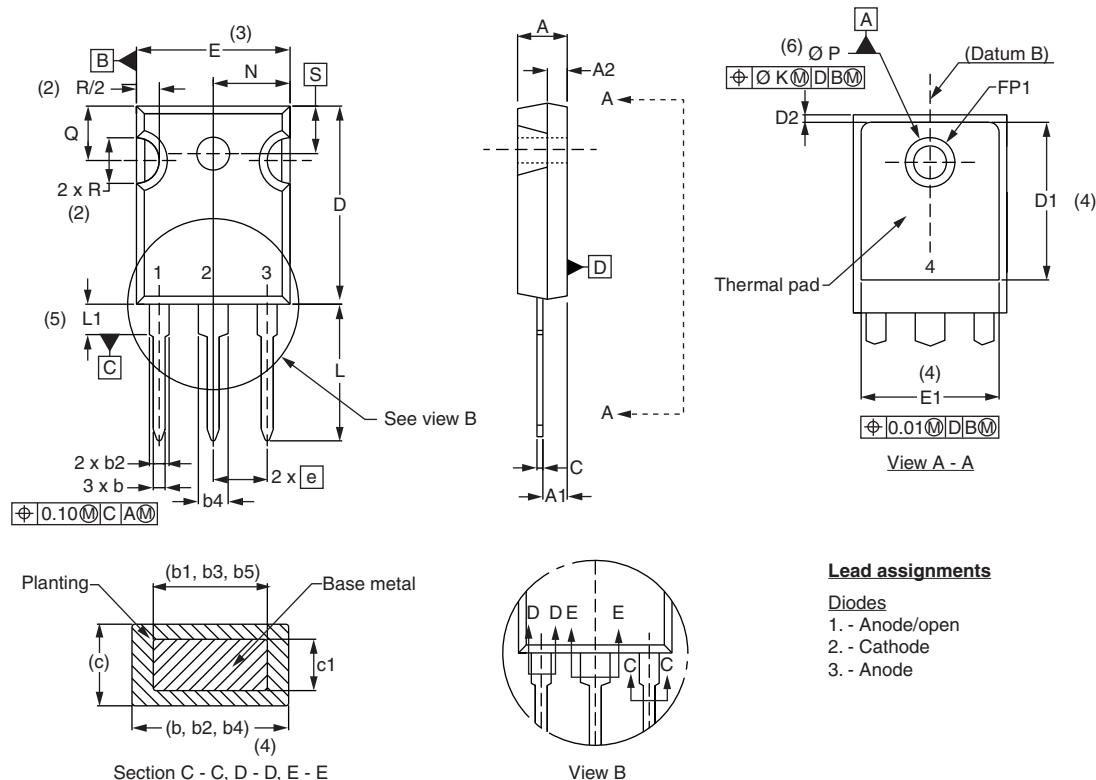
- (1) Formula used: $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$
 P_d = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 P_{dREV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = Rated V_R

**ORDERING INFORMATION TABLE**

Device code	MBR	40	45	WT	PbF
	1	2	3	4	5

- | | | |
|----------|---|---|
| 1 | - | Schottky MBR series |
| 2 | - | Current rating (40 = 40 A) |
| 3 | - | Voltage rating (45 = 45 V) |
| 4 | - | Circuit configuration:
Center tap (dual) TO-247 |
| 5 | - | <ul style="list-style-type: none">• None = Standard production• PbF = Lead (Pb)-free |

LINKS TO RELATED DOCUMENTS	
Dimensions	http://www.vishay.com/doc?95223
Part marking information	http://www.vishay.com/doc?95226
SPICE model	http://www.vishay.com/doc?95297

**DIMENSIONS** in millimeters and inches**Lead assignments****Diodes**

1. - Anode/open
2. - Cathode
3. - Anode

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.37	0.065	0.094	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
c	0.38	0.86	0.015	0.034	
c1	0.38	0.76	0.015	0.030	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.72	-	0.540	-	
e	5.46 BSC		0.215 BSC		
FK	2.54		0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.3		
ΦP	3.56	3.66	0.14	0.144	
$\Phi P1$	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	1.78	0.216	
S	5.51 BSC		0.217 BSC		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) ΦP to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC outline TO-247 with exception of dimension c



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